

## P-Channel Enhancement Mode Power MOSFET

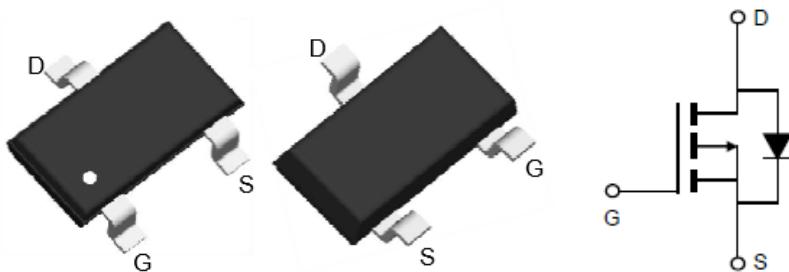
### ● Features

- $V_{DS} = -30V$ ,
- $I_D = -4A$
- $R_{DS(ON)} @ V_{GS} = -10V, TYP 46m\Omega$
- $R_{DS(ON)} @ V_{GS} = -4.5V, TYP 50m\Omega$
- $R_{DS(ON)} @ V_{GS} = -2.5V, TYP 63m\Omega$

### ● General Description

- Load Switch
- PWM

### ● Pin Configurations



**SOT23-3L**

### ● Absolute Maximum Ratings @ $T_A=25^\circ C$ unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		$V_{DSS}$	-30	V
Gate-Source Voltage		$V_{GSS}$	$\pm 12$	V
Drain Current (Continuous) *AC	$T_A=25^\circ C$	$I_D$	-4	A
	$T_A=70^\circ C$		-3.2	
Drain Current (Pulse) *B		$I_{DM}$	-15	A
Power Dissipation	$T_A=25^\circ C$	$P_D$	1.25	W
Operating Temperature/ Storage Temperature		$T_J/T_{STG}$	-55~150	°C

### ● Thermal Resistance Ratings

Parameter	Symbol	Maximum	Unit
Maximum Junction-to-Ambient	$t \leq 5S$	$R_{thJA}$	100 °C/W

● **Electrical Characteristics** @ $T_A=25^\circ C$  unless otherwise noted

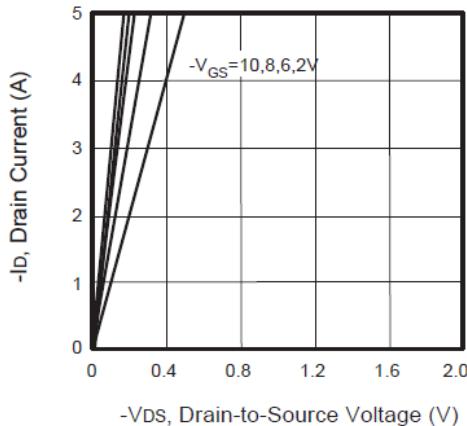
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30 V, V_{GS} = 0V$	--	--	-1	$\mu A$
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = -250\mu A$	-0.5	-0.9	-1.5	V
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS} = 0V$	--	--	$\pm 100$	nA
Drain-Source On-state Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -4A$	--	46	63	$m\Omega$
	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -3.5A$	--	50	75	$m\Omega$
	$R_{DS(on)}$	$V_{GS} = -2.5V, I_D = -1A$	--	63	120	$m\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = -5V, I_D = -3A$	4	--	--	S
Diode Forward Voltage	$V_{SD}$	$I_{SD} = -1A, V_{GS} = 0V$	--	--	-1.2	V
Diode Forward Current	$I_S$	$T_A = 25^\circ C$	--	--	-2	A
<b>Switching</b>						
Total Gate Charge	$Q_g$	$V_{GS} = -4.5V, V_{DS} = -15V, I_D = -4A$	--	9	--	nC
Gate-Source Charge	$Q_{gs}$		--	1	--	nC
Gate-Drain Charge	$Q_{gd}$		--	3	--	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -15V, R_G = 6\Omega$ $I_D = -4A, V_{GS} = -10V$	--	9	--	ns
Turn-on Rise Time	$t_r$		--	3	--	ns
Turn-off Delay Time	$t_{d(off)}$		--	66	--	ns
Turn-Off Fall Time	$t_f$		--	16	--	ns
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -15V, f = 1.0MHz$	--	945	--	pF
Output Capacitance	$C_{oss}$		--	120	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	80	--	pF

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design.

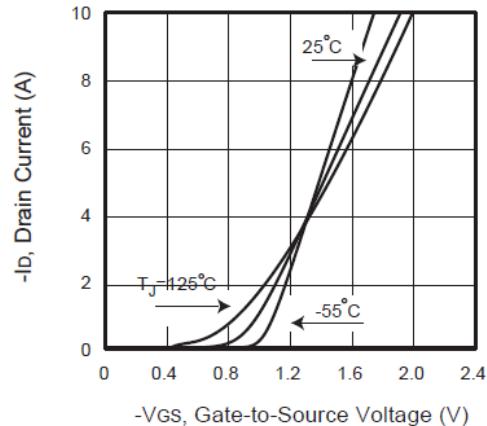
B: Repetitive rating, pulse width limited by junction temperature.

C: The current rating is based on the  $t \leq 10s$  junction to ambient thermal resistance rating.

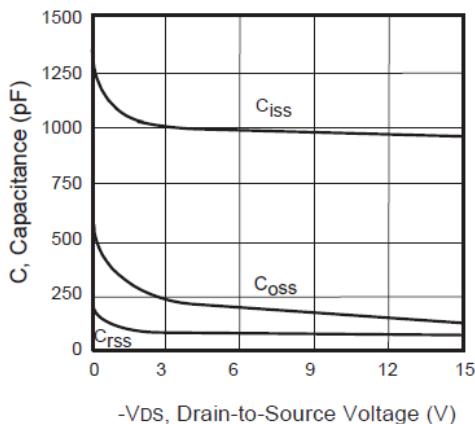
- **Typical Performance Characteristics** (( $T_J = 25^\circ\text{C}$ , unless otherwise noted))



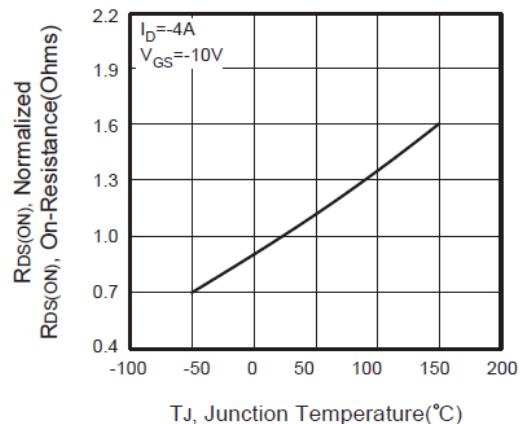
**Figure 1. Output Characteristics**



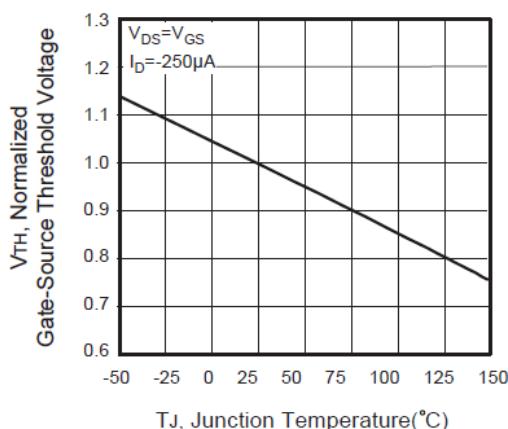
**Figure 2. Transfer Characteristics**



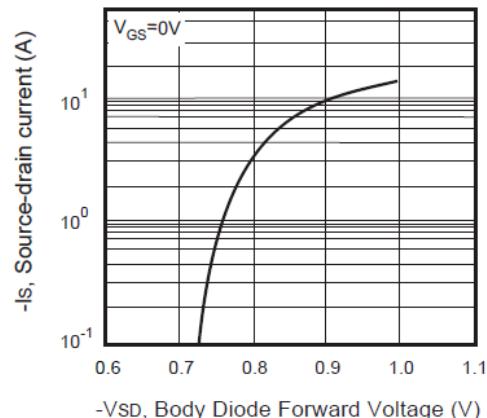
**Figure 3. Capacitance**



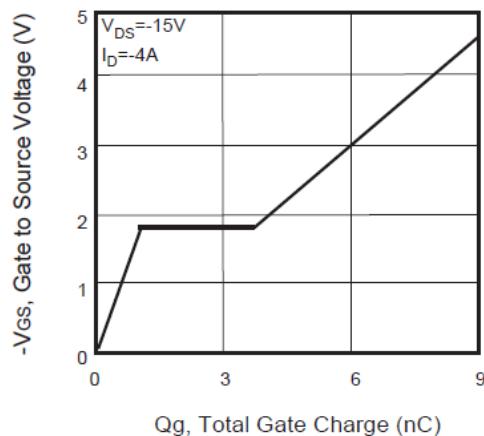
**Figure 4. On-Resistance Variation with Temperature**



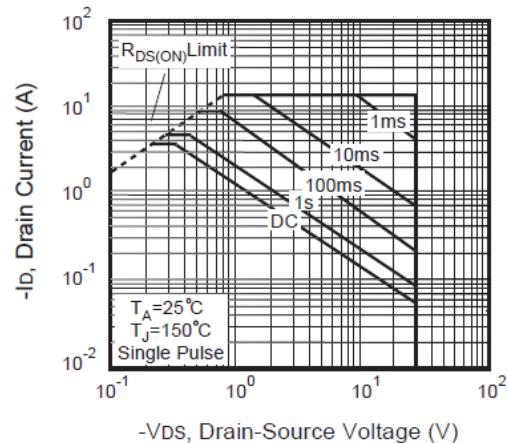
**Figure 5. Gate Threshold Variation with Temperature**



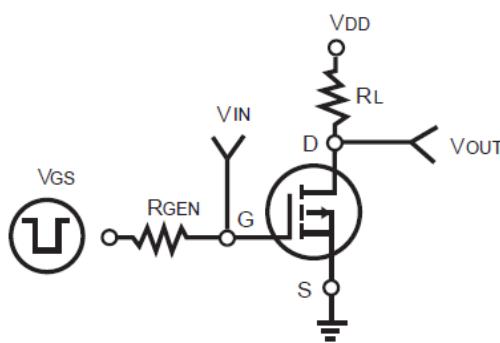
**Figure 6. Body Diode Forward Voltage Variation with Source Current**



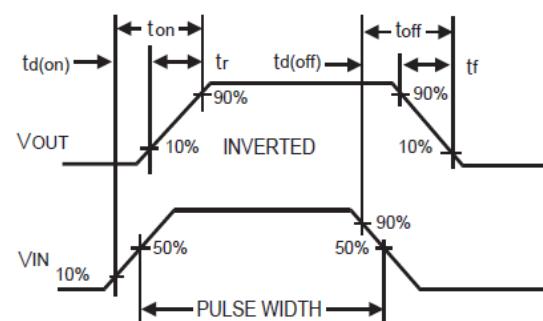
**Figure 7. Gate Charge**



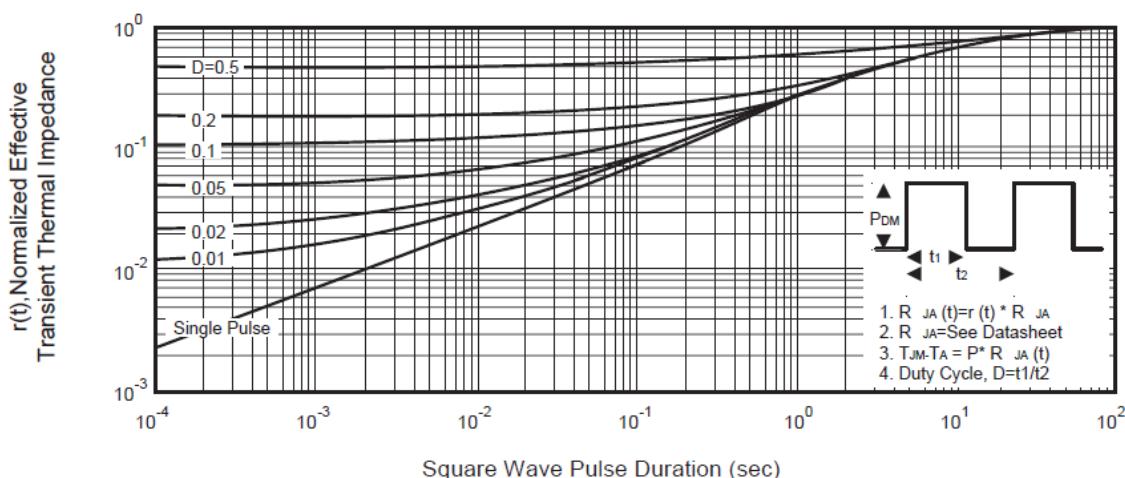
**Figure 8. Maximum Safe Operating Area**



**Figure 9. Switching Test Circuit**

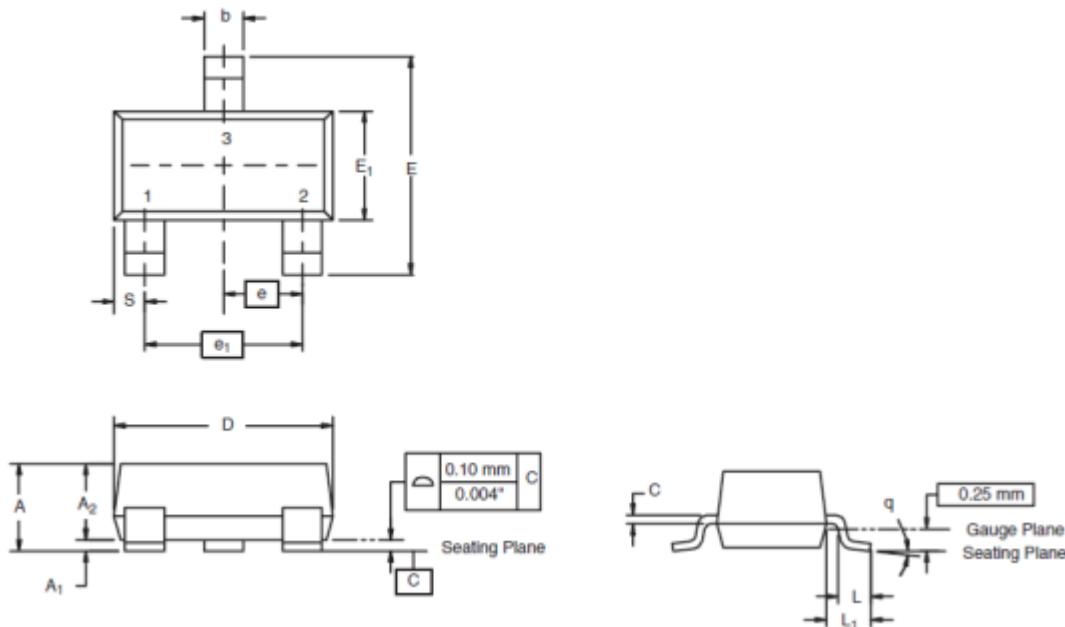


**Figure 10. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**

- Package Information



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.89	1.12	0.035	0.044
A <sub>1</sub>	0.01	0.10	0.0004	0.004
A <sub>2</sub>	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
c	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.60	3.00	0.102	0.118
E <sub>1</sub>	1.40	1.80	0.055	0.071
e	0.95 BSC		0.0374 Ref	
θ <sub>1</sub>	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L <sub>1</sub>	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°

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